■ MN101CA5 Series

Туре	MN101CA5F	MN101CFA5G
Internal ROM type	Mask ROM	FLASH
ROM (byte)	96K	128K
RAM (byte)	4K	10K
Package (Lead-free)	LQFP112-P-2020 (ES (Engineering Sample) available)	
Minimum Instruction Execution Time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz) 0.24 μs (at 2.7 V to 5.5 V, 8.4 MHz) 0.48 μs (at 2.3 V to 5.5 V, 4.19 MHz)* 1.0 μs (at 2.0 V to 5.5 V, 2.0 MHz)* 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)* *: The lower limit for operation guarantee for flash memory built-in type is 2.5 V.	

■ Interrupts

RESET. Watchdog. External 0 to 6. Timer 0 to 4. Timer 6. Timer 7 (2 systems). Timer 8 (2 systems). Time base. Serial 0 (2 systems). Serial 1 (2 systems). Serial 2. Serial 3 (2 systems). A/D conversion finish. Automatic transfer finish. FL display key scan. FL display dimmer

■ Timer Counter

8-bit timer \times 6

Input capture

Time base timer: One-minute count setting

Watchdog timer \times 1

■ Serial interface

Synchronous type/UART (full-duplex) \times 3: Serial 0, 1, 3 Synchronous type/Single-master I²C \times 1: Serial 2

■ DMA controller

Maximum transfer cycles: 255

Starting factor: External request. Various types of interrupt. Software

Transfer mode: 1-byte transfer. Word transfer. Burst transfer

■ I/O Pins

I/O 44: Common use. Specified pull-up resistor available. Input/output selectable (bit unit)

High Voltage 57: Output: 26. I/O: 31. P-ch. open drain (breakdown voltage -40 V): FL drive: 57. Specified pull-down resistor mask

ption: 39

■ A/D converter

8-bit \times 8 channels (with S/H)

■ Display control function

FL: $(35 \text{ to } 47) \text{ segments} \times (18 \text{ to } 10) \text{ digits}$

16 levels dimmer function

Light-and-dark 2-tones display function

Can support automatic display to universal grid display tubes

Output dimmer waveform for FL driver connection (DROUT)

Internal pull down resister is available between Port 6 and Vpp, Port 9 and Vpp, Port B and Vpp, Port C and Vpp, Port D and Vpp by Mask option (only for Mask ROM version)

Internal pull down resister between Port 4 and Vpp, Port 7 and Vpp, Port 8 and Vpp

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■ Special Ports

Buzzer output. Remote control carrier output. High-current drive port

■ ROM Correction

Correcting address designation: Up to 3 addresses possible

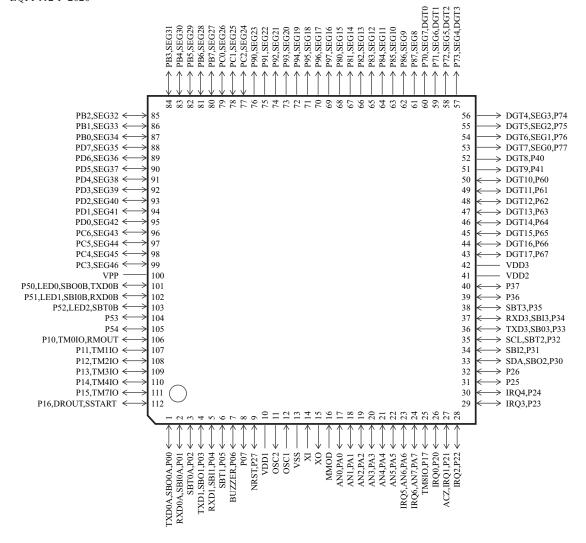
Development tools

In-circuit Emulator

PX-ICE101C/D + PX-PRB101CA3-LQFP112-P-2020-M

■ Pin Assignment

LQFP112-P-2020



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